2N7000KL/BS170KL

Vishay Siliconix

N-Channel 60-V (D-S) MOSFET

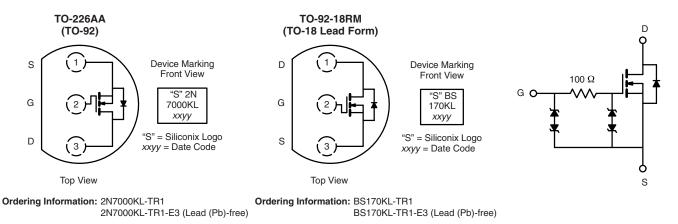
PRODUCT SUMMARY						
V _{DS} (V)	r _{DS(on)} (Ω)	V _{GS(th)} (V)	I _D (A)			
60	2 at V _{GS} = 10 V	1.0 to 2.5	0.47			
	4 at V _{GS} = 4.5 V	1.0 10 2.5	0.33			

FEATURES

- TrenchFET[®] Power MOSFET
- ESD Protected: 2000 V

APPLICATIONS

- Direct Logic-Level Interface: TTL/CMOS
- Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Display, Memories, Transistors, etc.
- Battery Operated Systems



ABSOLUTE MAXIMUM RATINGS $T_A = 25$	°C, unless otherwise	noted		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	60	V
Gate-Source Voltage		V _{GS}	± 20	
Quality of Design Connect (T. 150 CO) ^b	T _A = 25 °C	I	0.47	
Continuous Drain Current (T _J = 150 °C) ^b	T _A = 70 °C	I _D	0.37	А
Pulsed Drain Current ^a		I _{DM}	1.0	
	T _A = 25 °C	- P _D	0.8	w
Power Dissipation	T _A = 70 °C		0.51	
Maximum Junction-to-Ambient		R _{thJA}	158	°C/W
Operating Junction and Storage Temperature Range		T _{J,} T _{stg}	- 55 to 150	°C

Notes:

a. Pulse width limited by maximum junction temperature.

* Pb containing terminations are not RoHS compliant, exemptions may apply.





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Parameter	Symbol	Test Conditions	Limits			
			Min	Тур	Мах	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 10 μ A	60			v
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	2.0	2.5	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 10 V$			± 1	μΑ
Zero Gate Voltage Drain Current	I _{DSS} -	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1	
		V_{DS} = 60 V, V_{GS} = 0 V, T_{J} = 55 °C			10	
b	I _{D(on)}	$V_{GS} = 10 \text{ V}, V_{DS} = 7.5 \text{ V}$	0.8			Α
On-State Drain Current ^b		$V_{GS} = 4.5 \text{ V}, V_{DS} = 10 \text{ V}$	0.5			
Drain-Source On-Resistance ^b	r _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$		1.1	2	Ω
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 0.2 \text{ A}$		1.6	4	
Forward Transconductance ^b	9 _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$		550		ms
Diode Forward Voltage	V _{SD}	$I_{\rm S} = 0.3 \text{ A}, V_{\rm GS} = 0 \text{ V}$		0.87	1.3	V
Dynamic ^b			-	•	•	•
Total Gate Charge	Qg	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}$ $I_D \cong 0.25 \text{ A}$		0.4	0.6	nC
Gate-Source Charge	Q _{gs}			0.11		
Gate-Drain Charge	Q _{gd}			0.15		pF
Gate Resistance	R _g			173		
	t _{d(on)}			3.8	10	
Turn-On Time	t _r	V_{DD} = 30 V, R_L = 150 Ω		4.8	15	
T 0// T	t _{d(off)}	$I_D \cong 0.2 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_{G} = 10 \Omega$		12.8	20	ns
Turn-Off Time	t _f			9.6	15	

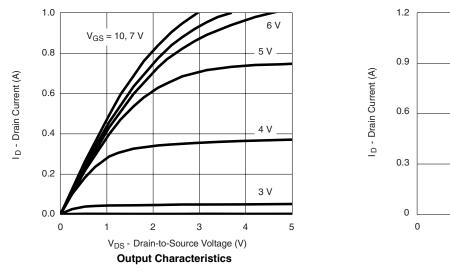
Notes:

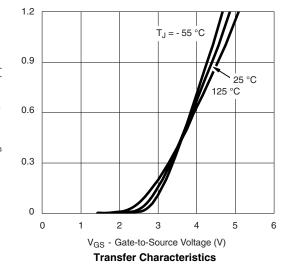
a. Pulse test: PW \leq 300 μs duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



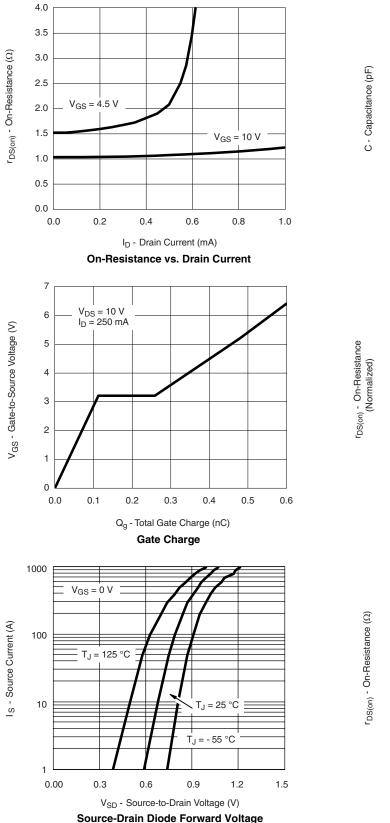


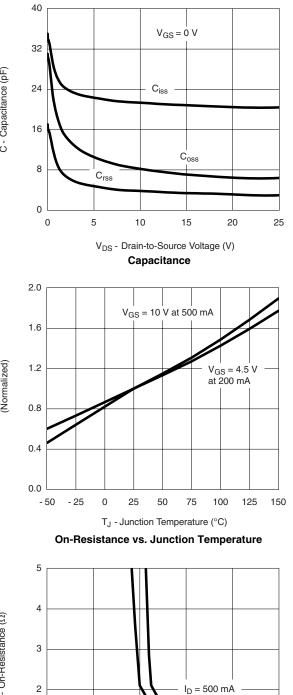


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





I_D = 200 mA

4

6

V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-Source Voltage

2

1

0

0

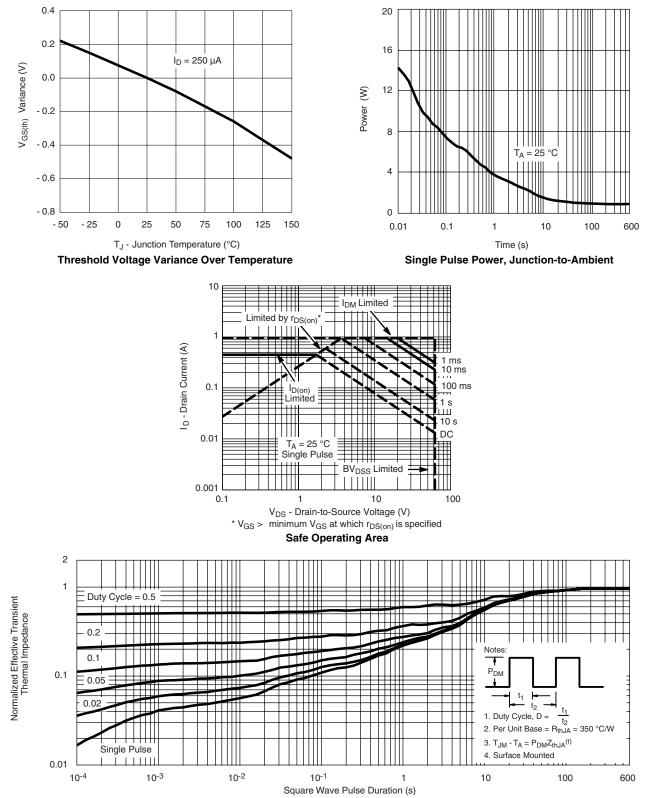
10

8

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72705.

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